Power Transistors Panasonic

2SD1747, 2SD1747A

Silicon NPN epitaxial planar type

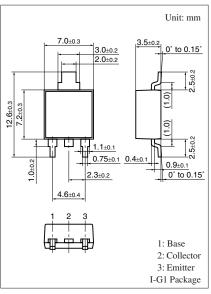
For power switching

■ Features

- Low collector-emitter saturation voltage V_{CE(sat)}
- \bullet Satisfactory liniarity of forward current transfer ratio h_{FE}
- Large collector current I_C
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SD1747	V _{CBO}	130	V
(Emitter open)	2SD1747A		150	
Collector-emitter voltage	2SD1747	V _{CEO}	80	V
(Base open)	2SD1747A		100	
Emitter-base voltage (Col	V_{EBO}	7	V	
Collector current	I_C	7	A	
Peak collector current	I_{CP}	15	A	
Collector power dissipation	P _C	15	W	
	$T_a = 25^{\circ}C$		1.3	
Junction temperature	T_j	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	



Note) Self-supported type package is also prepared.

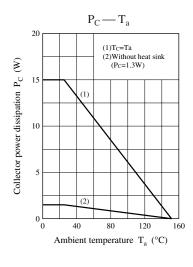
■ Electrical Characteristics $T_C = 25$ °C ± 3 °C

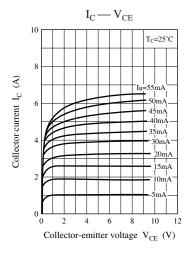
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SD1747	V _{CEO}	$I_C = 10 \text{ mA}, I_B = 0$	80			V
(Base open)	2SD1747A			100			
Collector-base cutoff current (E	mitter open)	I_{CBO}	$V_{CB} = 100 \text{ V}, I_E = 0$			10	μΑ
Emitter-base cutoff current (Col	llector open)	I_{EBO}	$V_{EB} = 5 \text{ V}, I_{C} = 0$			50	μΑ
Forward current transfer rat	io	h _{FE1}	$V_{CE} = 2 \text{ V}, I_{C} = 0.1 \text{ A}$	45			_
		h _{FE2} *	$V_{CE} = 2 \text{ V}, I_{C} = 3 \text{ A}$	90		260	
Collector-emitter saturation	voltage	V _{CE(sat)}	$I_C = 5 \text{ A}, I_B = 0.25 \text{ A}$			0.5	V
Base-emitter saturation volt	age	V _{BE(sat)}	$I_C = 5 \text{ A}, I_B = 0.25 \text{ A}$			1.5	V
Transition frequency		f_T	$V_{CE} = 10 \text{ V}, I_{C} = 0.5 \text{ A}, f = 10 \text{ MHz}$		30		MHz
Turn-on time		t _{on}	$I_C = 3 \text{ A}, I_{B1} = 0.3 \text{ A}, I_{B2} = -0.3 \text{ A}$		0.5		μs
Storage time		t _{stg}	$V_{CC} = 50 \text{ V}$		1.5		μs
Fall time		t _f			0.2		μs

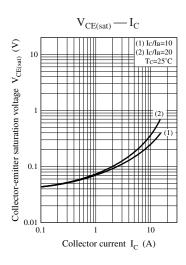
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

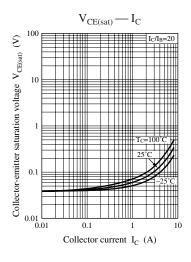
2. *: Rank classification

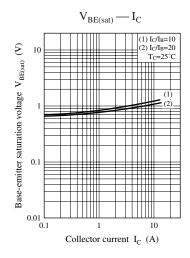
Rank	Q	Р		
$h_{\rm FE1}$	90 to 180	130 to 260		

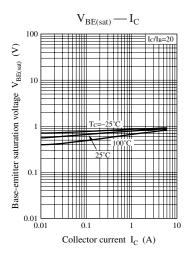


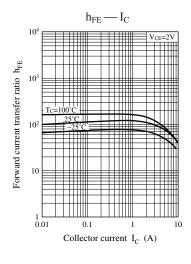


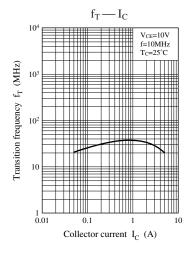


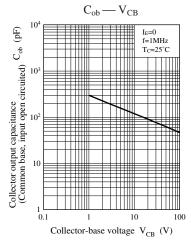


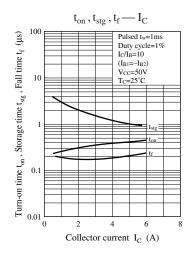


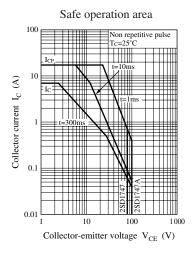


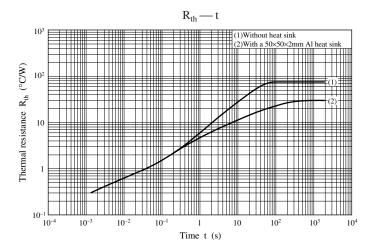












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